

IoT SuperServer SYS-220HE-FTNRD

2U Hyper with 6 SAS/SATA bays and DC PSU



More details here

Key Applications

Telecom Micro Data Center, AI Inference and Machine Learning, Cloud Computing, Network Function Virtualization (NFV), 5G Networking,

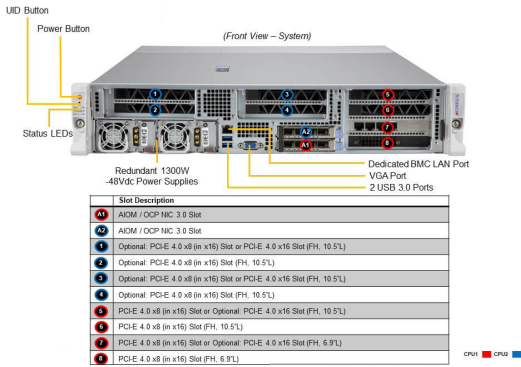
Key Features

- Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors;
- 32 DIMM Slots; Up to 8TB DRAM; Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM); 3200/2933/2666 ECC DDR4 LRDIMM; RDIMM; Intel® Optane™ Persistent Memory 200 series;
- 3 PCIe 4.0 x16 slots with GPU/Accelerator support (Default); 1 PCIe 4.0 x16 expansion slots (Optional);
- Flexible networking options with 2 AIOM networking slots (OCP NIC 3.0 compatible);
- Up to 6x 2.5" hot-swap drive bays with options to support NVMe/SATA drives;
- 6 heavy duty hot-swap fans with optimal fan speed control Front I/O, tool-less design;
- 1300W DC power supplies;



Form Factor	2U Rackmount Enclosure: 436.88 x 88.9 x 574mm (17.2" x 3.5" x 22.6") Package: 598 x 247 x 938mm (23.5" x 9.7" x 36.9")
Processor	Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processors
GPU	Max GPU Count: Up to 3 double-width or 3 single-width GPUs Supported GPU: NVIDIA PCIe: T4, A40, A100, A10 CPU-GPU Interconnect: PCIe 4.0 x16 CPU-to-GPU Interconnect GPU-GPU Interconnect: PCIe
System Memory	Slot Count: 32 DIMM slots Max Memory (2DPC): Up to 8TB 3200MT/s ECC DDR4 RDIMM/LRDIMM
Drive Bays Configuration	Default: Total 6 bays • 6 front hot-swap 2.5" NVMe/SAS/SATA drive bays M.2: 2 M.2 NVMe slots (M-key 2280/22110)
Expansion Slots	Default • 3 PCIe 4.0 x16 FHFL slots • 1 PCIe 4.0 x16 FHHL slot Option A • 6 PCIe 4.0 x8 (in x16) FHFL slots • 2 PCIe 4.0 x8 FHHL slots
On-Board Devices	SATA: SATA (6Gbps) ; RAID 0/1/5/10 support NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required) Chipset: Intel® C621A Network Connectivity: 2 RJ45 1GbE with Intel® I350-AM2 (optional) 4 SFP 1GbE with Intel® I350-AM4 (optional) 2 RJ45 10GBASE-T with Intel® X550-AT2 (optional) 2 SFP+ 10GbE with Intel® X710-BM2 (optional) 4 SFP+ 10GbE with Intel® XL710-BM1 (optional) 4 SFP+ 10GbE with Intel® X710-TM4 (optional) 2 SFP28 25GbE with Broadcom® BCM57414 (optional) 4 SFP28 25GbE (optional) 2 QSFP28 100GbE with Broadcom® BCM57508 (optional) 4 RJ45 1GbE with Intel® I350-AM4 (optional)
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port

USB: 2 USB 2.0 ports(front)
Video: 1 VGA port



Slot	Description
1 - 2	2.5" Hot-swap NVMe/SAS3/SATA3 Drive Bays (NVMe from CPU1)*
3 - 4	2.5" Hot-swap NVMe/SAS3/SATA3 Drive Bays (NVMe from CPU2)*

*SAS3 support requires additional parts in optional parts list

System Cooling

Fans: Up to 6 Counter-rotating, Hot-swappable 60x60x56mm Fan(s)
Air Shroud: 4 Air Shrouds

Power Supply

1x 1300W Redundant power supply

Management

SuperCloud Composer®; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!

PC Health Monitoring

CPU: Monitors for CPU Cores, Chipset Voltages, Memory
FAN: Fans with tachometer monitoring
Status monitor for speed control
Pulse Width Modulated (PWM) fan connectors
Temperature: Monitoring for CPU and chassis environment
Thermal Control for fan connectors

Dimensions and Weight

Weight: Gross Weight: 47.4 lbs (21.5 kg)
Net Weight: 34.4 lbs (15.6 kg)
Available Color: Silver

Operating Environment

Operating Temperature: 5°C to 35°C (41°F to 95°F)
Non-operating Temperature: -40°C to 70°C (-40°F to 158°F)
Operating Relative Humidity: 8% to 90% (non-condensing)
Non-operating Relative Humidity: 5% to 95% (non-condensing)

Motherboard

[Super X12DHM-6](#)

Chassis

CSE-HE211-R000NFP